

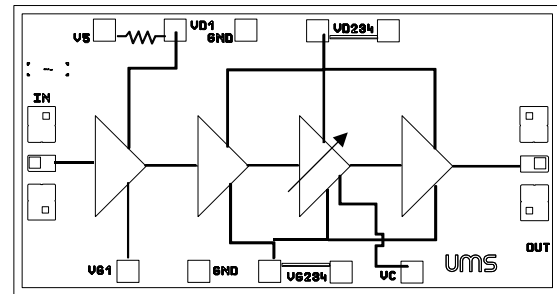
## 16-24GHz Low Noise, Variable Gain Amplifier GaAs Monolithic Microwave IC

### Description

The CHA2292-99F is a high gain four-stage monolithic low noise amplifier with variable gain. It is designed for a wide range of applications, from military to commercial communication systems. The backside of the chip is both RF and DC grounded. This helps simplify the assembly process.

The circuit is manufactured with a pHEMT process, 0.25µm gate length, via holes through the substrate, air bridges and electron beam gate lithography.

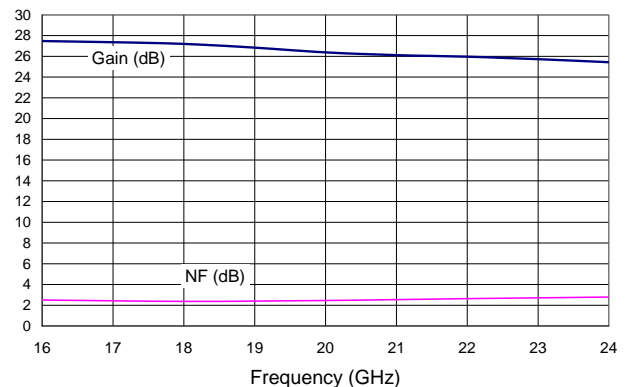
It is available in chip form.



### Main Features

- Frequency range: 16-24GHz
- 2.8dB Noise Figure.
- 25dB Gain
- 15dB Gain control range
- DC power consumption: 160mA @ 5V
- Chip size: 2.32 X 1.23 X 0.10mm

Typical on wafer measurements: Gain & NF



### Main Characteristics

Tamb.= +25°C

Symbol	Parameter	Min	Typ	Max	Unit
Fop	Operating frequency range	16		24	GHz
G	Small signal gain	24	26		dB
NF	Noise figure		2.8	3.5	dB
Gctrl	Gain control range with Vc variation	15	20		dB
Id	Bias current		160		mA

ESD Protection : Electrostatic discharge sensitive device. Observe handling precautions !

## Electrical Characteristics for Broadband Operation

Tamb = +25°C, V5=Vd2, 3, 4=5V

Symbol	Parameter	Min	Typ	Max	Unit
Fop	Operating frequency range	16		24	GHz
G	Small signal gain (1)	24	26		dB
ΔG	Small signal gain flatness (1)		±1		dB
Is	Reverse isolation (1)		50		dB
NF	Noise figure with Vc=1.2V		2.8	3.5	dB
Gctrl	Gain control range versus Vc	15	20		dB
P1dB	Output power at 1dB compression with Vc=1.2V		11		dBm
VSWRin	Input VSWR (1)		2.5:1	3.5:1	
VSWRout	Output VSWR (1)		2.0:1	3:1	
Vd	DC voltage V5= Vd2,3,4 Vc	-1.5	5 [-0.7, +1.2]	+1.3	V V
Id1	Bias current (2) with Vc=1.2V		35		mA
Id	Bias current total (3) with Vc=1.2V		160		mA

(1) These values are representative of on-wafer measurements that are made without bonding wires at RF ports.

(2) For optimum noise figure, the bias current Id1 should be adjusted to 35mA with Vg1 voltage.

(3) With Id1=35mA, adjust Vg2, 3, 4 voltage for a total drain current around 160mA.

## Absolute Maximum Ratings

Tamb. = 25°C (1)

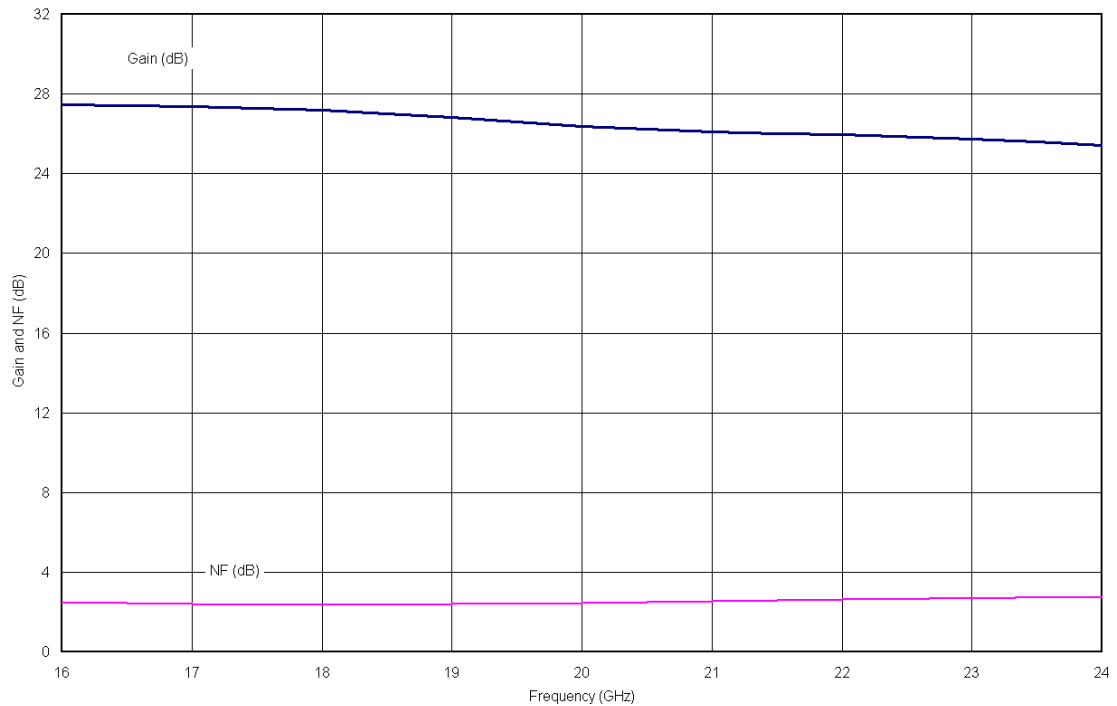
Symbol	Parameter	Values	Unit
Vd	Drain bias voltage	5.5	V
Vc	Control bias voltage	1.5	V
Id	Drain bias current	250	mA
Vg	Gate bias voltage	-2.0 to +0.4	V
Pin	Maximum peak input power overdrive (2)	+15	dBm
Ta	Operating temperature range	-40 to +85	°C
Tstg	Storage temperature range	-55 to +150	°C

(1) Operation of this device above any one of these parameters may cause permanent damage.

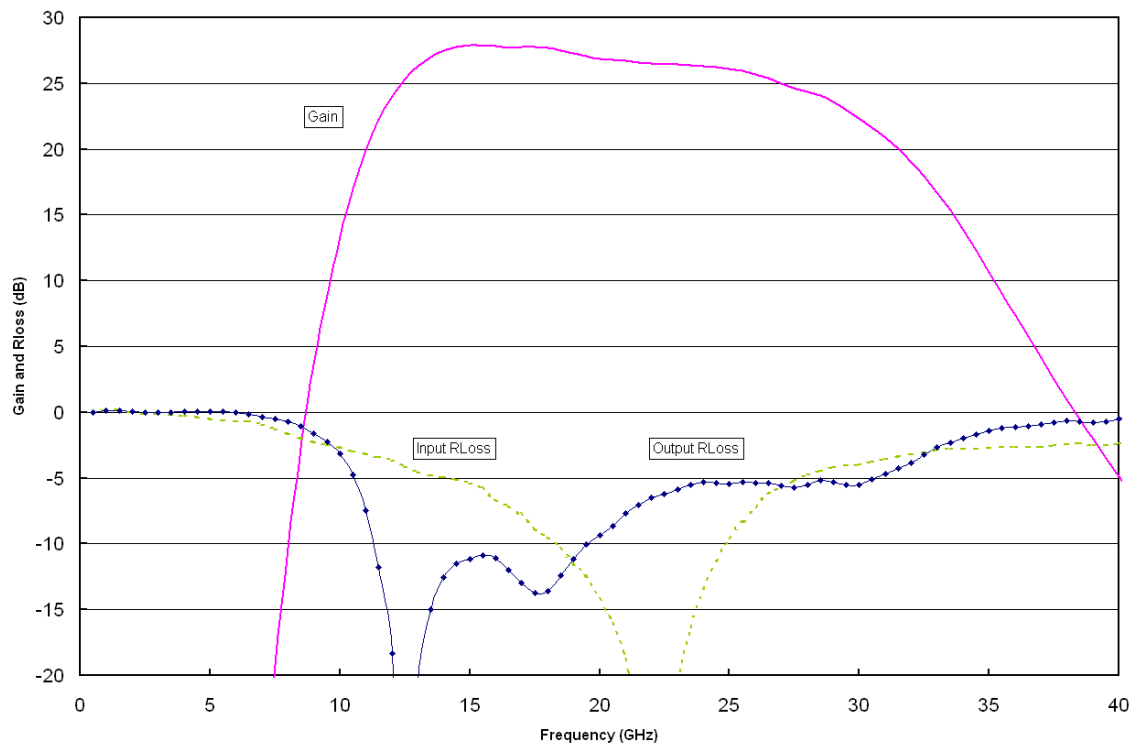
(2) Duration < 1s.

**Typical on wafer Measurements**

Bias Conditions:  $V_5=V_{d2, 3, 4}=5V$ ,  $V_{g1}$  for  $I_{d1}=35mA$ ,  $V_g=-0.3V$ ,  $V_c=+1.2V$



Gain & Noise Figure versus frequency



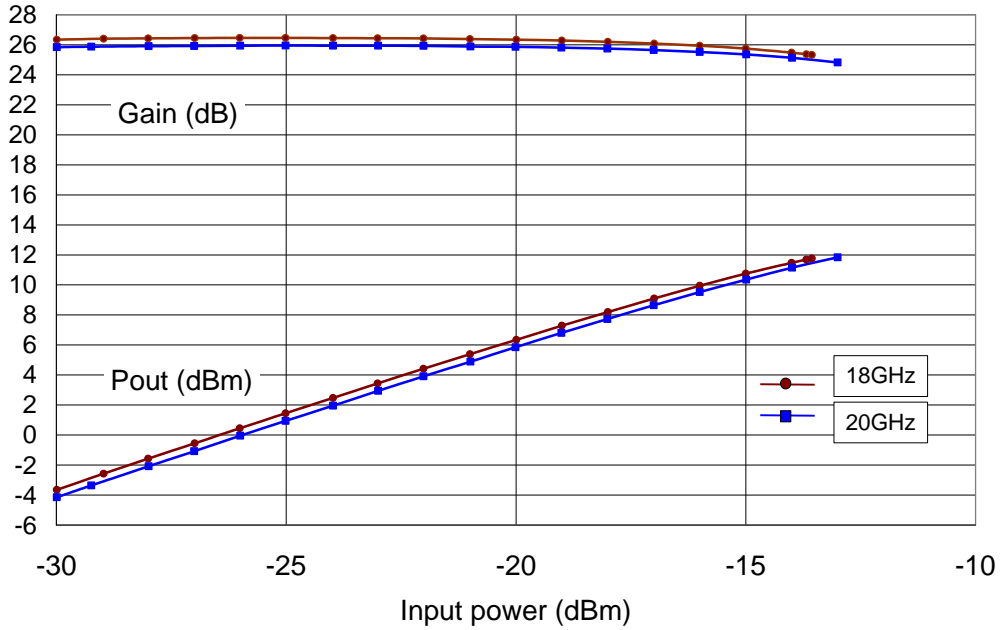
**Typical on-wafer Gain & Return Loss**



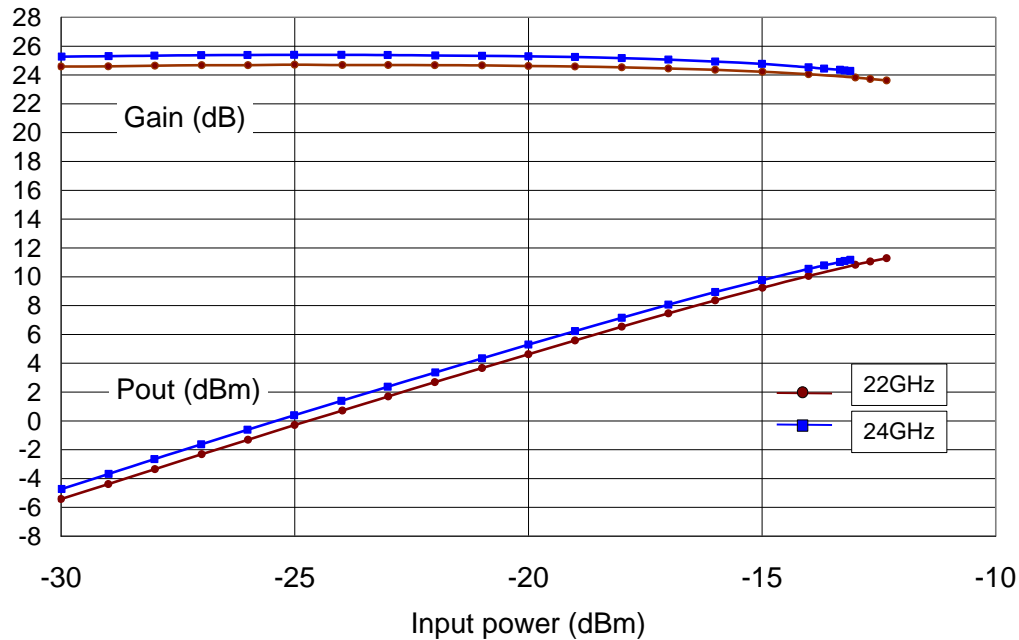
## In Jig Measurements

Bias Conditions:  $V_5=V_{d2, 3, 4}=5V$ ,  $V_{g1}=V_g=-0.3V$ ,  $V_c=+1.2V$

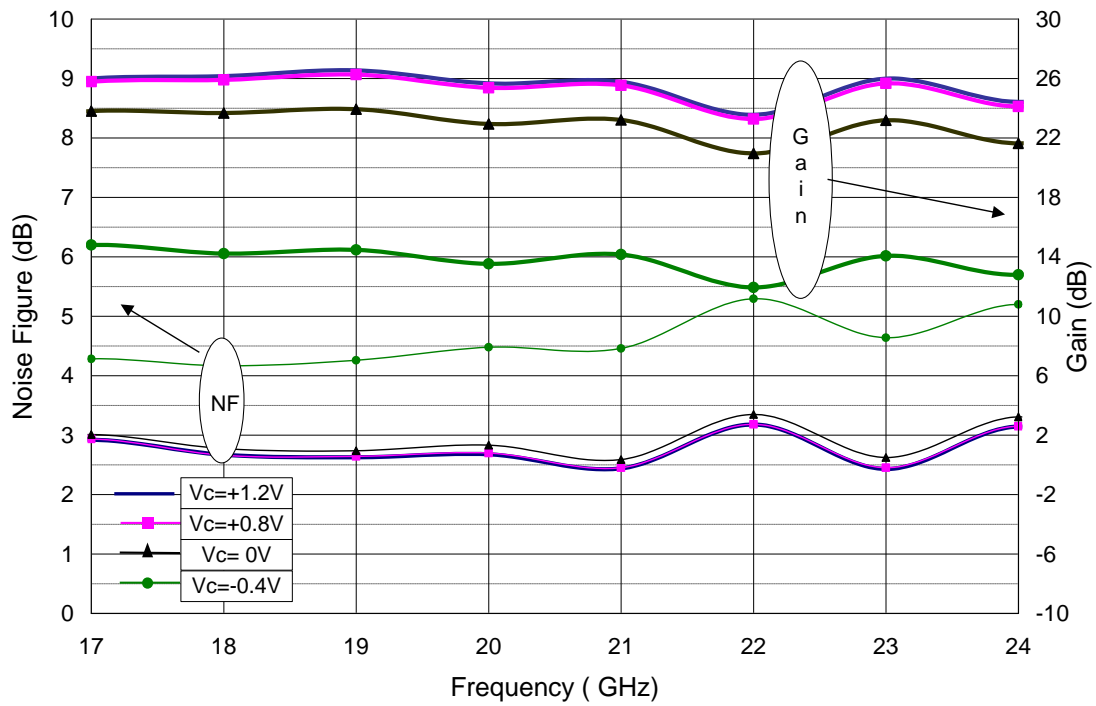
All these measurements include the jig losses (about 0.5dB on gain, 0.2dB on noise figure and 0.3dB on output power).



## Gain & Output power @ 18-20 GHz



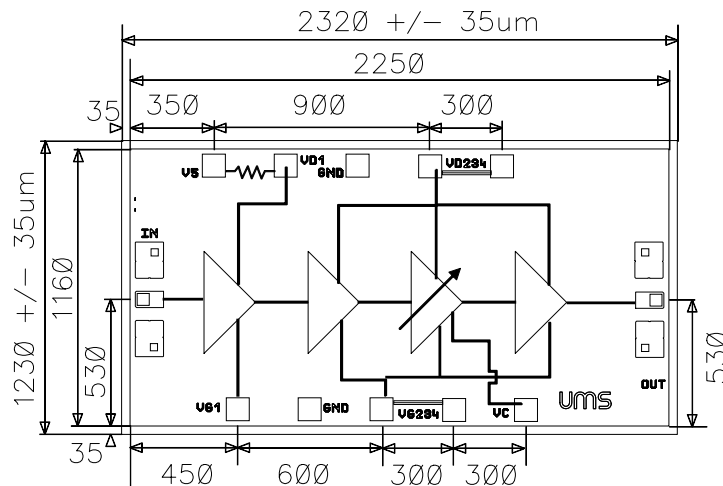
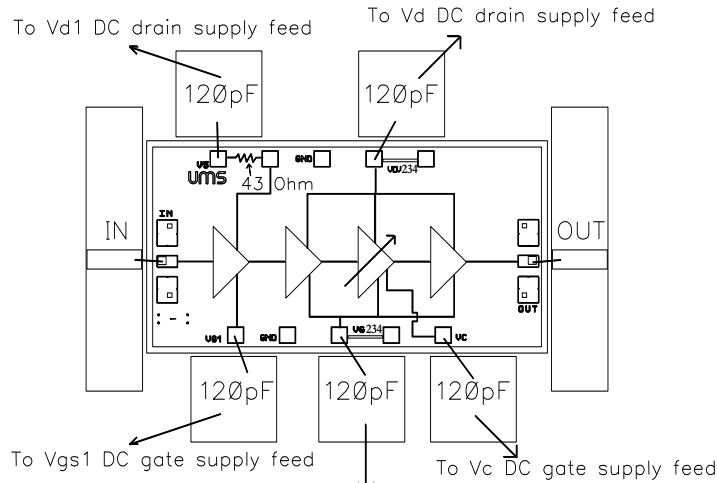
## Gain & Output power @ 22-24 GHz



Gain & Noise Figure versus Vc

## Chip Assembly and Mechanical Data

Note: Supply feed should be capacitively bypassed. 25µm diameter gold wire is recommended  
Bond Pad: 100 x 100µm



**Bonding pad**  
(Chip thickness:

dimensions are in micrometers)

**positions**  
100µm. All

## Ordering Information

Chip form : CHA2292-99F/00

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